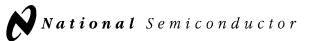
DS75361

DS75361 Dual TTL-to-MOS Driver



Literature Number: SNOSBR4A



DS75361 Dual TTL-to-MOS Driver

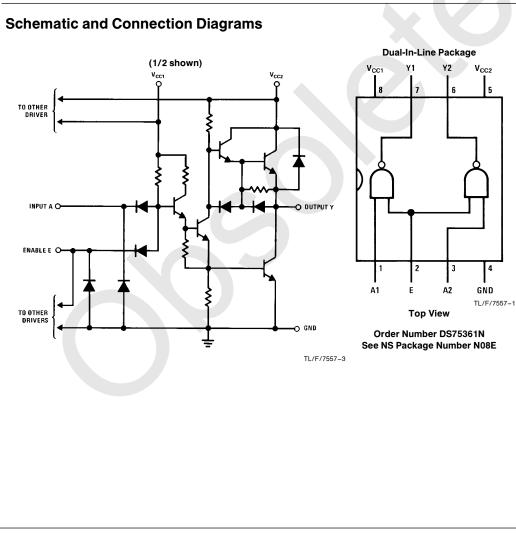
General Description

The DS75361 is a monolithic integrated dual TTL-to-MOS driver interface circuit. The device accepts standard TTL input signals and provides high-current and high-voltage output levels for driving MOS circuits. It is used to drive address, control, and timing inputs for several types of MOS RAMs including the 1103 and MM5270 and MM5280.

The DS75361 operates from standard TTL 5V supplies and the MOS V_{SS} supply in many applications. The device has been optimized for operation with V_{CC2} supply voltage from 16V to 20V; however, it is designed for use over a much wider range of V_{CC2}.

Features

- Capable of driving high-capacitance loads
- Compatible with many popular MOS RAMs
- \blacksquare V_{CC2} supply voltage variable over wide range to 24V
- Diode-clamped inputs
- TTL compatible
- Operates from standard bipolar and MOS supplies
- High-speed switching
- Transient overdrive minimizes power dissipation
- Low standby power dissipation



© 1995 National Semiconductor Corporation TL/F/7557

RRD-B30M105/Printed in U. S. A.

DS75361 Dual TTL-to-MOS Driver

September 1992

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage Range of V _{CC1} (Note 1)	-0.5 to 7V
Supply Voltage Range of V_{CC2}	-0.5V to 25V
Input Voltage	5.5V
Inter-Input Voltage (Note 4)	5.5V
Storage Temperature Range	$-65^{\circ}C$ to $+150^{\circ}C$
Maximum Power Dissipation* at 25°C	
Molded Package	1022 mW

Lead Temperature 1/16 inch from Case for	
10 Seconds: N or P Package	200°C
*Derate molded package 8.2 mW/° above about 25°C.	

Operating Conditions

	Min	Max	Units
Supply Voltage (V _{CC1})	4.75	5.25	V
Supply Voltage (V _{CC2})	4.75	24	V
Operating Temperature (T _A)	0	+70	°C

Electrical Characteristics (Notes 2 and 3)

Symbol	Parameter	Condit	tions	Min	Тур	Max	Units
VIH	High-Level Input Voltage			2			V
VIL	Low-Level Input Voltage					0.8	V
VI	Input Clamp Voltage	$I_{\rm I} = -12 {\rm mA}$				-1.5	v
V _{OH}	High-Level Output Voltage	$V_{IL} = 0.8V, I_{OH} = -50 \ \mu A$		V _{CC2} - 1	V _{CC2} - 0.7		V
		$V_{IL} = 0.8V, I_{OH} = -10 \text{ mA}$		V _{CC2} - 2.3	V _{CC2} - 1.8		V
V _{OL}	Low-Level Output Voltage	$V_{IH} = 2V, I_{OL} = 10 \text{ mA}$			0.15	0.3	V
		$\label{eq:VCC2} \begin{split} V_{CC2} &= 15V \text{ to } 24V, V_{IH} = 2V, \\ I_{OL} &= 40 \text{ mA} \end{split}$			0.25	0.5	v
Vo	Output Clamp Voltage	$V_{I} = 0V, I_{OH} = 20 \text{ mA}$				V _{CC2} + 1.5	V
l	Input Current at Maximum Input Voltage	$V_{I} = 5.5V$				1	mA
Iн	High-Level Input Current	$V_{I} = 2.4V$	A Inputs			40	μΑ
			E Input			80	μA
Ι _{ΙL}	Low-Level Input Current $V_{I} = 0.4V$	$V_{\rm r} = 0.4 V$	A Inputs		-1	-1.6	mA
		V - 0.4V	E Input		-2	-3.2	mA
I _{CC1(H)}	Supply Current from V _{CC1} , Both Outputs High	$V_{CC1} = 5.25V_{2}$	$V_{222} = 24V$		2	4	mA
I _{CC2(H)}	Supply Current from V _{CC2} , Both Outputs High	All Inputs at 0V,				0.5	mA
I _{CC1(L)}	Supply Current from V _{CC1} , Both Outputs Low	$V_{\rm CC1} = 5.25V_{\rm r}$	$V_{222} = 24V$		16	24	mA
I _{CC2(L)}	Supply Current from V _{CC2} , Both Outputs Low	All Inputs at 5V,	No Load		7	11	mA
I _{CC2(S)}	Supply Current from V _{CC2} , Stand-by Condition	$V_{CC1} = 0V,$ All Inputs at 5V,				0.5	mA

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

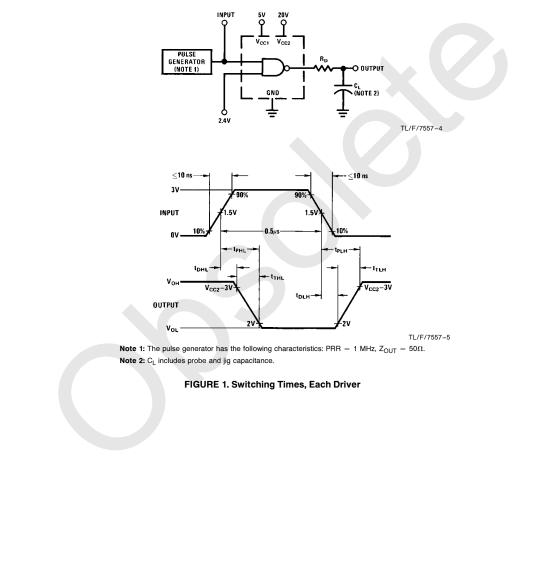
Note 2: Unless otherwise specified min/max limits apply across the 0°C to +70°C range for the DS75361. All typical values are for T_A = 25°C and V_{CC1} = 5V and V_{CC2} = 20V.

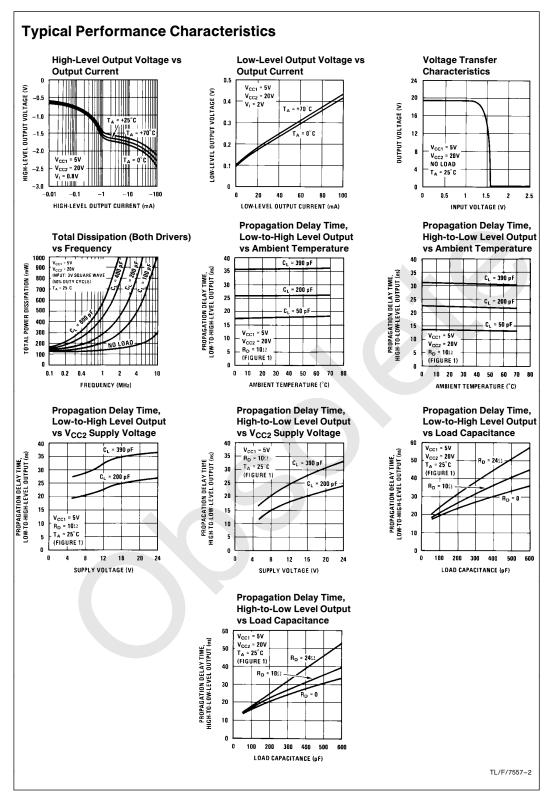
Note 3: All currents into device pins shown as positive, out of device pins as negative, all voltages referenced to ground unless otherwise noted. All values shown as max or min on absolute value basis.

Note 4: This rating applies between the A input of either driver and the common E input.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{DLH}	Delay Time, Low-to-High Level Output	$C_L = 390 \text{ pF},$ $R_D = 10\Omega$		11	20	ns
t _{DHL}	Delay Time, High-to-Low Level Output			10	18	ns
t _{TLH}	Transition Time, Low-to-High Level Output			25	40	ns
t _{THL}	Transition Time, High-to-Low Level Output	(Figure 1)		21	35	ns
tPLH	Propagation Delay Time, Low-to-High Level Output		10	36	55	ns
t _{PHL}	Propagation Delay Time, High-to-Low Level Output]	10	31	47	ns

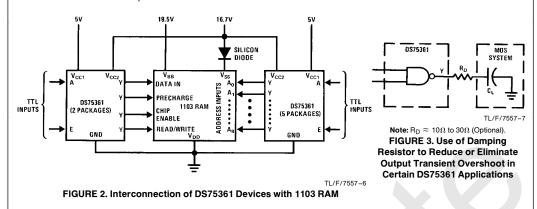
AC Test Circuit and Switching Time Waveforms





Typical Applications

The fast switching speeds of this device may produce undesirable output transient overshoot because of load or wiring inductance. A small series damping resistor may be used to reduce or eliminate this output transient overshoot. The optimum value of the damping resistor to use depends on the specific load characteristics and switching speed. A typical value would be between 10Ω and 30Ω (*Figure 3*).



Thermal Information

POWER DISSIPATION PRECAUTIONS

Significant power may be dissipated in the DS75361 driver when charging and discharging high-capacitance loads over a wide voltage range at high frequencies. The total dissipation curve shows the power dissipated in a typical DS75361 as a function of load capacitance and frequency. Average power dissipated by this driver can be broken into three components:

 $P_{T(AV)} = P_{DC(AV)} + P_{C(AV)} + P_{S(AV)}$

where $\mathsf{P}_{DC(AV)}$ is the steady-state power dissipation with the output high or low, $\mathsf{P}_{C(AV)}$ is the power level during charging or discharging of the load capacitance, and $\mathsf{P}_{S(AV)}$ is the power dissipation during switching between the low and high levels. None of these include energy transferred to the load and all are averaged over a full cycle.

The power components per driver channel are:

$$P_{DC(AV)} = \frac{P_{L}t_{L} + P_{H}t_{H}}{T}$$
$$P_{C(AV)} \approx C V_{C}^{2} f$$
$$P_{S(AV)} = \frac{P_{LH}t_{LH} + P_{HL}t_{H}}{T}$$

T where the times are defined in *Figure 4*.

 P_L , P_H , P_{LH} , and P_{HL} are the respective instantaneous levels of power dissipation and C is load capacitance.

The DS75361 is so designed that P_S is a negligible portion of P_T in most applications. Except at very high frequencies, $t_L + t_H \gg t_{LH} + t_{HL}$ so that P_S can be neglected. The total dissipation curve for no load demonstrates this point. The power dissipation contributions from both channels are then added together to obtain total device power.

The following example illustrates this power calculation technique. Assume both channels are operating identically with C = 200 pF, f = 2 MHz, V_{CC1} = 5V, V_{CC2} = 20V, and duty cycle = 60% outputs high (t_H/T = 0.6). Also, assume V_{OH} = 19.3V, V_{OL} = 0.1V, P_S is negligible, and that the current from V_{CC2} is negligible when the output is high. On a per-channel basis using data sheet values:

$$P_{\text{DC(AV)}} = \left[(5V) \left(\frac{2 \text{ mA}}{2}\right) + (20V) \left(\frac{0 \text{ mA}}{2}\right) \right] (0.6) + \left[(5V) \left(\frac{16 \text{ mA}}{2}\right) + (20V) \left(\frac{7 \text{ mA}}{2}\right) \right] (0.4)$$

 $P_{DC(AV)} = 47 \text{ mW per channel}$

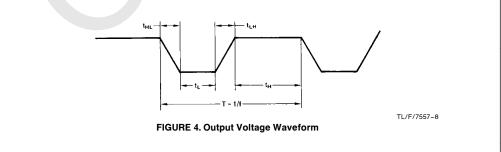
 ${\rm P}_{\rm C(AV)}\,\approx\,$ (200 pF) (19.2V)² (2 MHz)

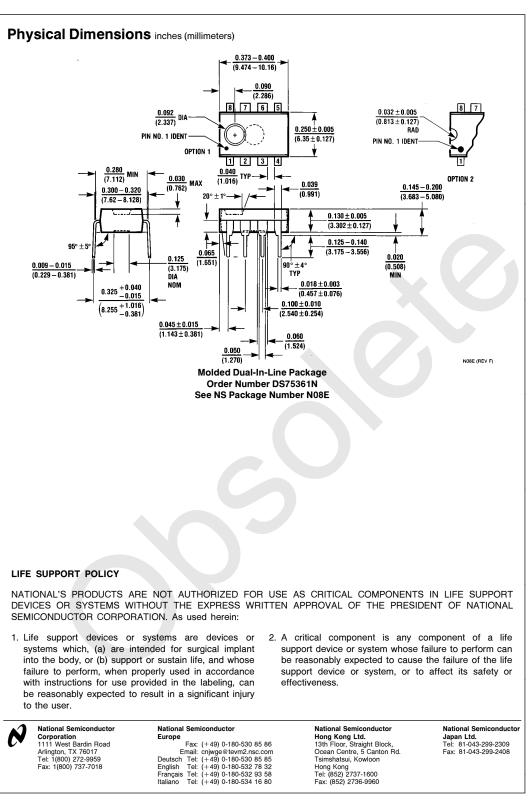
 $P_{C(AV)}\,\approx\,$ 148 mW per channel.

For the total device dissipation of the two channels:

 $P_{T(AV)} \approx 2 (47 + 148)$

 $P_{T(AV)} \approx 390$ mW typical for total package.





National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Audio	www.ti.com/audio	Communications and Telecom	www.ti.com/communications
Amplifiers	amplifier.ti.com	Computers and Peripherals	www.ti.com/computers
Data Converters	dataconverter.ti.com	Consumer Electronics	www.ti.com/consumer-apps
DLP® Products	www.dlp.com	Energy and Lighting	www.ti.com/energy
DSP	dsp.ti.com	Industrial	www.ti.com/industrial
Clocks and Timers	www.ti.com/clocks	Medical	www.ti.com/medical
Interface	interface.ti.com	Security	www.ti.com/security
Logic	logic.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Power Mgmt	power.ti.com	Transportation and Automotive	www.ti.com/automotive
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Mobile Processors	www.ti.com/omap		
Wireless Connectivity	www.ti.com/wirelessconnectivity		
		u Hama Dawa	a O a Al a a m

TI E2E Community Home Page

e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2011, Texas Instruments Incorporated